# LM53625xQEVM and LM53635xQEVM

# **User's Guide**



Literature Number: SNVU526 May 2016



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# LM53625xQEVM and LM53635xQEVM User's Guide

#### 1 Introduction

The LM53635xEVM is specifically designed for automotive applications, providing a fixed output voltage of 5 V, 3.3 V, or an adjustable output voltage at 3.5-A continuous load. The LM53625xEVM is implemented using the same board and components but with or an IC with current limit set for 2.5 A maximum continuous load.

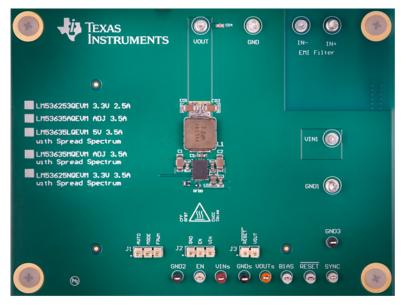


Figure 1. LM53625xQEVM and LM53635xQEVM Evaluation Board - Top View

All aspects of the LM53625xQEVM and LM53635xQEVM are optimized for the automotive market. An input voltage range to 36 V eases input surge protection design. Exceptional dropout performance allows the elimination of a boost stage in many designs for start/stop applications. An open drain RESET output, with filtering and Power-GOOD delay, provides a true indication of system status. This feature negates the requirement for additional supervisory circuitry, saving cost, and board space. Seamless transition between PWM and PFM operation AUTO MODE, along with a low quiescent current, ensures high efficiency at all loads. The Texas Instruments LM53625QEVM and LM53635xQEVM helps to evaluate the operation and performance of the LM53625x and LM53635x and is available for order in five variants. See Table 1 of orderable EVM variants and configuration.

Table 1. Orderable EVM Variants and Configuration for LM53625 and LM53635

EVM VARIANT	EVM ORDERABLE NAME	IC U1	CONTINUOUS LOAD	OUTPUT VOLTAGE	SPREAD SPECTRUM
001	LM536253QEVM	LM536253QRNLRQ1	2.5 A	3.3 V Fixed	_
002	LM53635AQEVM	LM53635AQRNLRQ1	3.5 A	5 V Adjusted	_
003	LM53635LQEVM	LM53635LQRNLRQ1	3.5 A	5 V Fixed	Yes
004	LM53635MQEVM	LM53635MQRNLRQ1	3.5 A	5 V Adjusted	Yes
005	LM53635NQEVM	LM53635NQRNLRQ1	3.5 A	3.3 V Fixed	Yes



## 2 Technical Specification EVM Board

Table 2 shows specifications for the LM53625xQEVM and LM53635xQEVM board.

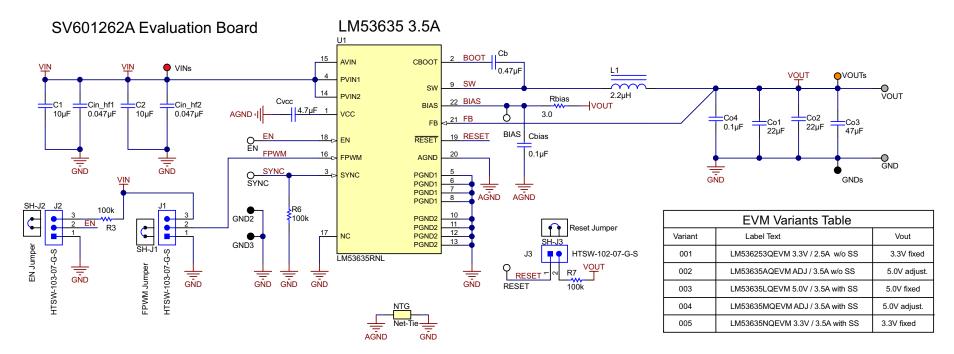
#### **Table 2. Technical Specification**

BOARD SIZE		
4000 × 3000 mil	101 mm × 76 mm	76 cm <sup>2</sup>
BOARD LAYER	•	
4-Layer FR4 PCB	Top Layer1 and Bottom Layer2 Mid Layer2 and Mid Layer3	2.8 mil 2 oz. Cu 1.4 mil 1 oz. Cu
SOLUTION SIZE		
860 mil × 490 mil	22 mm × 12.5 mm	2.75 cm <sup>2</sup>
POWER INPUT	<u>'</u>	
VIN1 and GND1 IN+ / IN-	Power Supply Input Power Input for EMI Test	typical 13.5 V (range 3.5 to 36 V) transient typical 13.5 V
Power Output:	•	
VOUT and GND	Power Output to Load	typical 3.3 V or 5 V
JUMPERS	·	
J1 FPWM pin J2 ENABLE pin J3 RESET pin	Auto Mode or Forced PWM Enable LM536325x and LM536335x Open drain output	Set – Default [AUTO-MODE] Set – Default [EN-VIN] Optional - [RESET-VOUT]
TEST POINTS		
GNDs, GND2 and GND3 EN VINs VOUTs BIAS RESET SYNC	Sense GND Points Enable Pin Voltage Input Voltage Sense Output Voltage Sense BIAS Voltage Sense RESET output Switch node SYNC input	If J2[EN-VIN] then VIN1 3.5 - 36 V Sense VIN1 3.5 to 36 V Sense VOUT typical 3.3 V or 5 V Sense BIAS typical 3.3 V or 5 V If J3 [RESET-VOUT] then VOUTs external sync frequency source



www.ti.com Schematics

#### 3 Schematics



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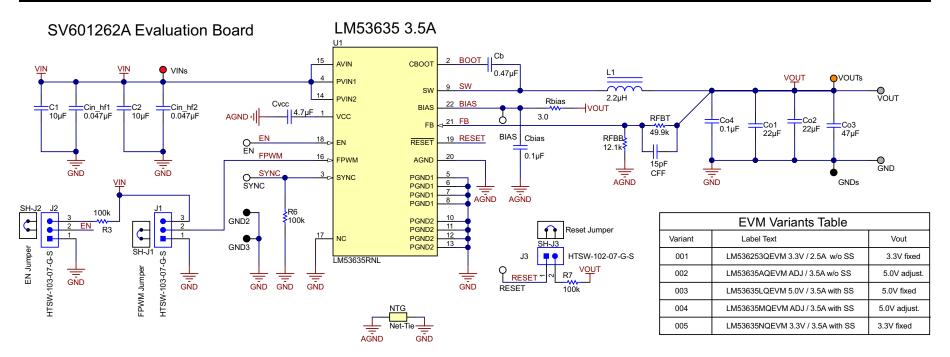
Figure 2. Fixed - Output Voltage Option Schematic

The fixed voltage option has an internal resistor divider and FB pin that connects directly to Cout capacitor.

NOTE: Cvcc and Cbias must connect directly to pin 20 AGND.



Schematics www.ti.com



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Figure 3. Adjustable - Output Voltage Option Schematic

Adjustable option uses external resistor divider to define output voltage. The CFF capacitor can be adjusted to make the feedback loop response faster for load transient. By lowering the total resistance of the feedback divider the noise immunity can be increased.

**NOTE:** To minimize noise coupling into the feedback pin, the maximum resistance recommended in the feedback resistors RFBB and RFBT is 50  $k\Omega$ . The feedback resistors RFBB and RFBT must be placed as close to the FB pin as possible, and RFBB must be grounded to AGND pin.



www.ti.com **Board Layout** 

#### 4 **Board Layout**

The LM53635xQEVM uses a four-layer PCB stack-up design. Top Layer 1 and Bottom Layer 4 are implemented using 2 oz. copper for optimized heat transfer and dissipation. Mid Layer 2 and Mid Layer 3 utilize 1 oz. copper. Total PCB thickness is 61 mil (1.55 mm).

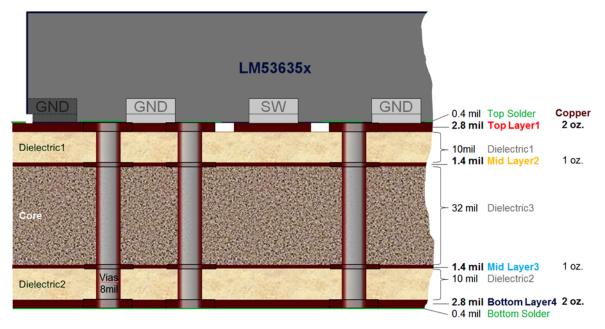


Figure 4. Four-Layer PCB Stack-Up

The overall EVM PCB board size dimension is 4000 mil x 3000 mil (101 mm x 76 mm) with a top surface area of 76 cm<sup>2</sup>. All vias on the PCB are constructed using 8-mil drill thru-hole with 16-mil pad size.

Figure 5 to Figure 8 shows the PCB Layout for each Cu Layer. Top Layer1 and Bottom Layer4 are constructed using large filled Cu areas connected to GND. This is done to improve thermal performance as well as improve overall EMI performance. Mid Layer 2 is constructed using a large GND plane as well. The intention here is to minimize loop inductance by placing metal right under the Top Layer 1 traces minimizing the cross section of current loops. Mid Layer 3 is mainly used to route non-critical signal traces to the IC.

NOTE: The PCB board layout is not fully optimized to use for final applications, but gives a good starting point. The layout can be simplified and optimized by eliminating features included for evaluation purposes such as measurement sense lines, jumper connections and features unused in a particular application such as the feedback resistor divider for fixed voltage options.



Board Layout www.ti.com

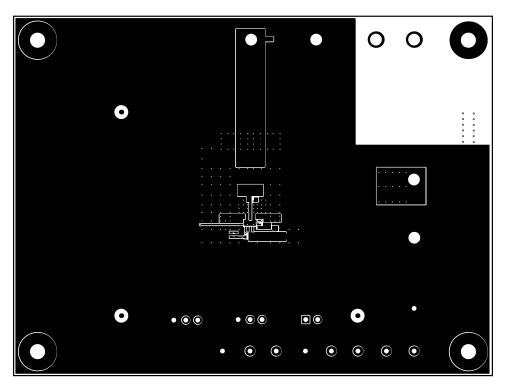


Figure 5. PCB Layout Top Layer 1 – Top View

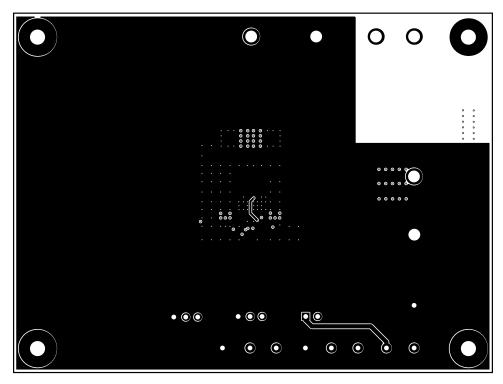


Figure 6. PCB Layout Mid Layer 2 GND Plane - Top View



www.ti.com Board Layout

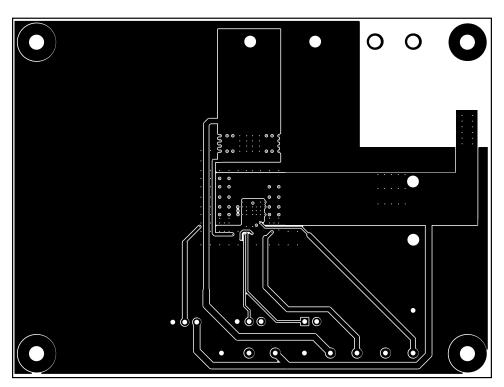


Figure 7. PCB Layer Mid Layer 3 – Top View

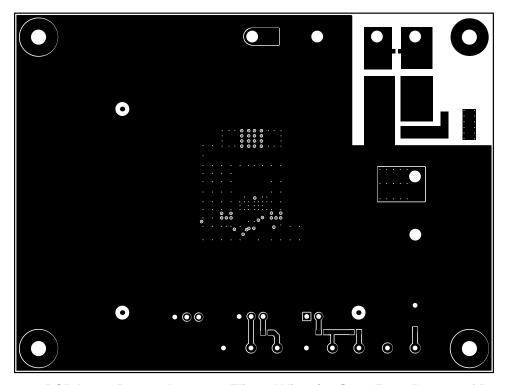


Figure 8. PCB Layer Bottom Layer 4 – Flipped View (as Seen From Bottom of Board)



Board Layout www.ti.com

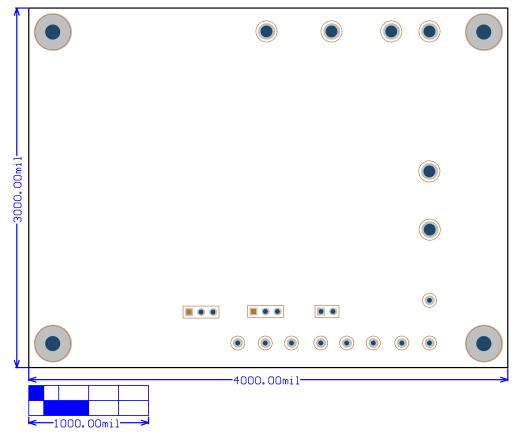


Figure 9. PCB Layer 5 - Dimensions

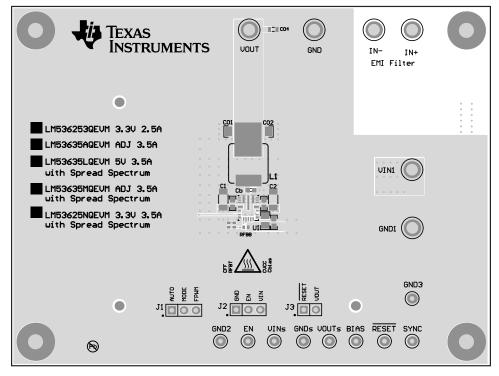


Figure 10. PCB Layer 7 Composite Top



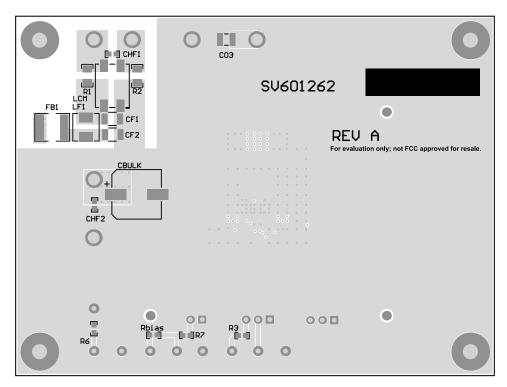


Figure 11. PCB Layer 6 Composite Bottom

#### 5 Operation and Test Setup

#### 5.1 Efficiency Measurement

 Connect power supply to posts VIN1 and GND1 and make sure the power supply provides sufficient current.

**NOTE:** There is no reverse polarity protection or fuse on the evaluation board.

2. Connect electronic load to posts VOUT and GND. For all power wires use preferable twisted lab wires. If the power supply wires are very long > 50 cm please solder additional 470  $\mu$ F, 50 V bulk capacitor to posts VIN1 and GND1. Always use sufficient power wires and separate measurement sense wires.

**NOTE:** These sense lines are not designed to carry power.

- 3. To accurately sense input and output voltage use the test points VINs, VOUTs, and GNDs. Alternatively sense wires can be soldered directly over input capacitors C1 or C2 and the output capacitors C01 or C02.
- 4. Make sure the IC is enabled by having jumper J2 set to [EN-VIN] and check test point EN is driven high. While measuring Iq (unloaded input current) remove all the input and output voltage probes that are most likely causing additional current draw.

**NOTE:** If the jumper J1 is set to [MODE-FPWM] the part will have a lower efficiency at light loads by maintaining the 2.1-MHz switch frequency. To measure the highest light load efficiency place the Jumper J1 in [AUTO-MODE].



#### 5.2 Measure Load Transient

 Connect power supply to posts VIN1 and GND1 and make sure the power supply can provide sufficient peak current.

NOTE: There is no reverse polarity protection or fuse on the evaluation board.

high and not drooping during the load transient.

- Connect transient load to posts VOUT and GND. For all power wires use preferable twisted lab wires.
   If the power supply wires are very long > 50 cm; solder additional 470 μF, 50 V bulk capacitor to posts
   VIN1 and GND1. Use sufficient power wires to avoid voltage drops and use short sense probe
   connection for the measurement.
- 3. To accurately sense the output voltage, the scope probe should be placed directly over the output capacitors C01 or C02. Make sure to connect scope probe GND ring directly to the output capacitor GND pad for minimal ground loop. Ground loops can introduce ringing in observed waveforms which is an artifact; not present on the PCB. Alternatively use differential probe over output capacitors C01 or C02. Do not use wires to differential probe and always probe directly with shortest possible pins.
  Make sure the IC is enabled by having jumper J2 set to [EN-VIN] and check test point EN is driven

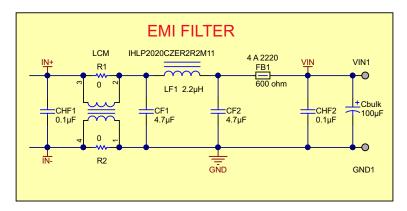
#### 5.3 Measure EMI

 Connect power supply cable from LISN to posts IN+ and IN- and make sure the board is placed 5 cm above the table.

NOTE: The length of the LISN cable to VIN+/VIN- should be between 20 cm to 40 cm for conducted EMI CISPR 25.

2. Connect resistive load directly to posts VOUT and GND. Use extremely short leads.

**NOTE:** To accurately measure EMI make sure the table has good ground connection to the chamber, connect the battery GND cable to ground table, and do not touch the board and setup or close the switch node. The board has a very effective 3-stage EMI filter where the common mode choke is not assembled by default. If the common mode choke is added, remove the bypass resistors R1 and R2.



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Figure 12. 3-Stage EMI Filter Schematic



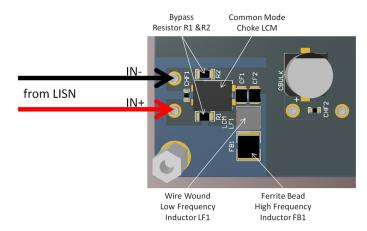


Figure 13. Position of the EMI Filter Components on PCB – Bottom Layer

#### 6 Posts, Probes, and Jumpers

#### 6.1 VIN1 and GND1 Posts

Standard input posts from power supply to operate EVM. The maximum input voltage is 36 V with 42 V absolute maximum transient.

#### 6.2 VOUT and GND Posts

Standard output posts to load. Use sufficient lab cables and preferable twist them to reduce inductive parasitic of lab cables. The typical output voltage is 5 V or 3.3 V.

#### 6.3 IN+ and IN- Posts

Standard Input posts for EMI Measurements so the IC is operated with EMI input Filter. By default there is a 2-stage filter assembled with a wire wound Inductor PI-Filter for low frequency filtering followed by stage utilizing a ferrite bead for high frequency filtering. If one wishes to measure a setup with a common mode choke; add the choke and remove bypass resistors R1 and R2.

#### 6.4 EN and GND2 Probe

EN and GND2 probe can be used to measure the enable voltage or drive it from external source. If an external source is used make sure to remove jumper J2. By default J2 jumper is set EN to VIN.

#### 6.5 VINs, VOUTs, and GNDs Probe

VINs and VOUTs are sense points for input and output voltage.

**NOTE:** Do not use for power supply or load.

These probe points are intended for use as kelvin sense point for static measurements like efficiency or line- or load regulation. For dynamic measurements please measure directly over the input capacitors C1 and C2 or directly over the output capacitor CO1 and CO2.

#### 6.6 BIAS and GNDS Probe

BIAS probe senses the bias voltage to the IC. Bias voltage is provided from the output voltage of the IC over Rbias =  $3 \Omega$  resistor. An external Bias supply voltage can be provided by removing Rbias located on bottom side of PCB to disconnect IC output voltage as source for bias.



#### 6.7 RESET and GND3 Probe

RESET provides an accurate power good signal with release delay. By default jumper J3 is set to VOUT and pulls the RESET pin to VOUT through a 100-k $\Omega$  resistor. RESET is an open drain output so it can be pulled to other external voltage levels by removing jumper J3.

#### 6.8 SYNC and GND3 Probe

By default the IC is running with internal oscillator at 2.1 MHz. There are IC options available with and without internal spread spectrum modulation. Over the SYNC pin, an external function generator can be connected to take control of the LM53625 and LM53635's clock, changing switching frequency. SYNC function is responsive enough to be used for custom frequency modulation techniques.

#### 6.9 Jumper J1

Jumper J1 sets light load operation mode of the IC. If set to [AUTO-MODE] when lightly loaded the IC goes automatically into PFM mode operation with fewer switching pulses and higher efficiency. The IC can be set into forced PWM mode (jumper position is marked *FPWM*) to operate with a constant switching frequency over the entire load range. This forced FPWM mode of operation will have best load transient behavior as well because there is no operation mode change during load transient steps.

#### 6.10 Jumper J2

Jumper J2 enables the IC. By default it is set to [EN-VIN] and pulls the enable pin through a  $100-k\Omega$  resistor to Vin. If an external source drives the EN pin then remove jumper J2 and use probe points EN and GND2 or use a 3-pin wire connector directly plugged over J2.

#### 6.11 **Jumper J3**

Jumper J3 pulls the open drain  $\overline{\text{RESET}}$  output to VOUT through a 100-k $\Omega$  resistor. If another  $\overline{\text{RESET}}$  output level is needed use probe point  $\overline{\text{RESET}}$  and pullup resistor to external reference voltage and remove jumper J3.

#### 7 Bill of Materials

Table 3. Bill of Materials

DESIGNATOR	QTY	VALUE	DESCRIPTION	PART NUMBER
BIAS, EN, RESET, SYNC	4		Test Point, Miniature, White, TH	5002
C1, C2	1, C2 2 10 μF CAP, CERM, 10 μF, 50 V, ±10%, X5R, 1206_109		GRM31CR61H106KA12L	
Cb	1	0.47 μF	CAP, CERM, 0.47 μF, 25 V, ±10%, X5R, 0603	GRM188R61E474KA12D
Cbias, Co4	s, Co4 2 0.1 μF CAP, CERM, 0.1 μF, 16 V, ±10%, X7R, AEC-Q200 Grade 1, 0603		GCM188R71C104KA37J	
Cbulk	k 1 100 $\mu$ F CAP, Aluminum Polymer, 100 $\mu$ F, 50 V, $\pm$ 20%, 0.025 $\Omega$ , AEC-Q200 Grade-2		HHXB500ARA101MJA0G	
CF1, CF2	2	4.7 μF	CAP, CERM, 4.7 µF, 50 V, ±20%, X7R, AEC-Q200 Grade 1, 1210	CGA6P3X7R1H475M250AB
CHF1, CHF2	2	0.1 μF	CAP, CERM, 0.1 µF, 16 V, ±10%, X7R, AEC-Q200 Grade 1, 0603	CGJ3E2X7R1C104K080AA
Cin_hf1, Cin_hf2	2	0.047 μF	CAP, CERM, 0.047 μF, 50 V, +/- 10%, X7R, 0603	GRM188R71H473KA61D
Co1, Co2	2	22 µF	CAP, CERM, 22 μF, 10 V, ±10, X7R, 1206	GRM31CR71A226KE15L
Co3	1	47 µF	CAP, CERM, 47 µF, 10 V, ±10, X7R, 1210	GRM32ER71A476KE15L
Cvcc	1	4.7 μF	CAP, CERM, 4.7 µF, 16 V, ±10%, X7R, AEC-Q200 Grade 1, 0805	GCM21BR71C475KA73L
FB1	1	600 Ω	Ferrite Bead, 600 Ω at 100 MHz, 4 A, 2220	HI2220P601R-10
GND, GND1, IN+, IN-, VIN1, VOUT			1502-2	
GND2, GND3, GNDs	3	Black	Test Point, Miniature, Black, TH	5001
H1, H2, H3, H4	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	NY PMS 440 0025 PH



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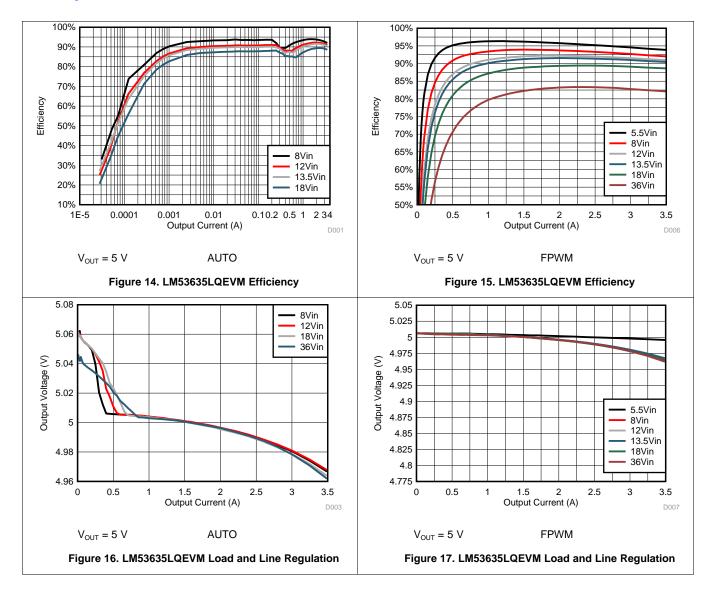
## Table 3. Bill of Materials (continued)

DESIGNATOR	QTY	VALUE	DESCRIPTION	PART NUMBER	
H5, H6, H7, H8	4		Standoff, Hex, 0.5"L #4-40 Nylon	1902C	
J1, J2	, J2 2		Header, 100 mil, 3x1, Gold, TH	HTSW-103-07-G-S	
J3 1			Header, 100 mil, 2x1, Gold, TH	HTSW-102-07-G-S	
L1 1 2.2 μH		2.2 µH	Inductor, Shielded, Powdered Iron, 2.2 μH, 10.2 A, 0.00941 Ω, SMD	IHLP3232DZER2R2M11	
LCM	_CM 0		Coupled inductor, 5 A, 0.01 Ω, SMD	ACM9070-701-2PL-TL01	
LF1	1	2.2 µH	Inductor, Shielded Drum Core, Powdered Iron, 2.2 $\mu$ H, 5.5 A, 0.025 $\Omega$ , SMD	IHLP2020CZER2R2M11	
R1, R2	2	0 Ω	RES, 0Ω, 5% 0.25 W, 1206	CRCW12060000Z0EA	
R3, R6, R7	3	100 k	RES, 100 K, 5%, 0.1 W, 0603	CRCW0603100KJNEA	
Rbias	1	3 Ω	RES, 3 Ω, 5%, 0.1 W, 0603	CRCW06033R00JNEA	
SH-J1, SH-J2, SH-J3	3	1×2	Shunt, 100 mil, Gold plated, Black	969102-0000-DA	
VINs	1		Test Point, Miniature, Red, TH	5000	
VOUTs	1		Test Point, Miniature, Orange, TH	5003	
Variant 001			LM536253QEVM Fixed 3.3 V, 2.5 A Without Spread Spec	etrum	
U1	1		2.5/3.5 A Synchronous Buck Regulator for Automotive Applications, RNL0022A	LM536253QRNLRQ1	
RFBB	0	DNP			
RFBT	1	0 Ω	2.5/3.5 A Synchronous Buck Regulator for Automotive Applications, RNL0022A	CRCW04020000Z0ED	
CFF	0	DNP			
Variant 002			LM53635AQEVM Adjustable 5 V, 3.5 A Without Spread Spectrum		
U1	1		2.5/3.5 A Synchronous Buck Regulator for Automotive Applications, RNL0022A	LM53635AQRNLRQ1	
RFBB	1	12.1 k	RES, 12.1 k, 1%, 0.063 W, 0402	CRCW040212K1FKED	
RFBT	1	49.9 k	RES, 49.9 k, 1%, 0.063 W, 0402	CRCW040249K9FKED	
CFF	1	15 pF	CAP, CERM, 15 pF, 50 V, ±5%, C0G/NP0, 0402	GRM1555C1H150JA01D	
Variant 003			LM53635LQEVM Fixed 5 V, 3.5 A With Spread Spectrum		
U1	1		2.5/3.5A Synchronous Buck Regulator for Automotive Applications, RNL0022A	LM53635LQRNLRQ1	
RFBB	0	DNP			
RFBT	1	0 Ω	RES, 0 Ω, 5%, 0.063 W, 0402	CRCW04020000Z0ED	
CFF	0	DNP			
Variant 004			LM53635MQEVM Adjustable 5 V, 3.5 A With Spread Spectrum		
U1	1		2.5/3.5A Synchronous Buck Regulator for Automotive Applications, RNL0022A	LM53635MQRNLRQ1	
RFBB	1	12.1 k	RES, 12.1 k, 1%, 0.063 W, 0402	CRCW040212K1FKED	
RFBT	1	49.9 k	RES, 49.9 k, 1%, 0.063 W, 0402	CRCW040249K9FKED	
CFF	1	15 pF	CAP, CERM, 15 pF, 50 V, ±5%, C0G/NP0, 0402	GRM1555C1H150JA01D	
Variant 005			LM53635NQEVM Fixed 3.3 V, 3.5 A With Spread Spectrum		
U1	1		2.5/3.5A Synchronous Buck Regulator for Automotive Applications, RNL0022A	LM53635NQRNLRQ1	
RFBB	0	DNP			
RFBT	1	0 Ω	RES, 0 Ω, 5%, 0.063 W, 0402	CRCW04020000Z0ED	
CFF	0	DNP			



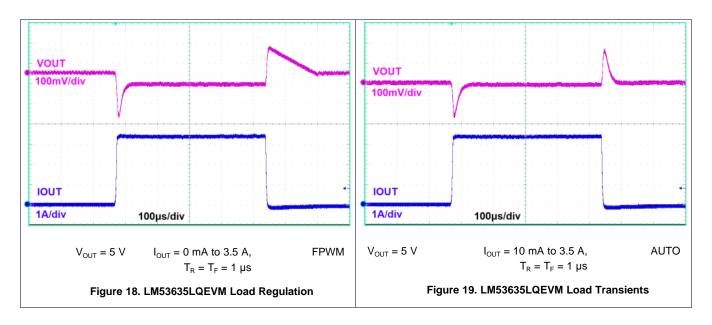
### 8 Efficiency and Line- and Load-Regulation

The variant of the board LM53635LQEVM is used for all measurements and curves in Figure 14 to Figure 23.





#### 8.1 Load Transients



#### 8.2 Conducted EMI



Figure 20. Conducted EMI Setup - Front View

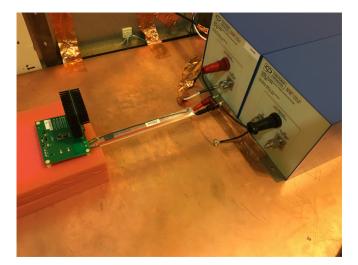
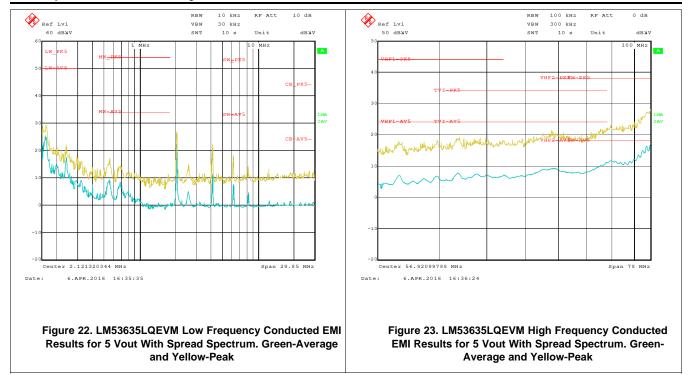


Figure 21. Conducted EMI Setup - Side View





#### STANDARD TERMS AND CONDITIONS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.
  - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms and conditions that accompany such Software
  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
  - 2.1 These terms and conditions do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI. Moreover, TI shall not be liable for any defects that result from User's design, specifications or instructions for such EVMs. Testing and other quality control techniques are used to the extent TI deems necessary or as mandated by government requirements. TI does not test all parameters of each EVM.
  - 2.3 If any EVM fails to conform to the warranty set forth above, Tl's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC - FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### **CAUTION**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

#### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

#### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see <a href="http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page">http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page</a> 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
  http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 4 EVM Use Restrictions and Warnings:
  - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
  - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
  - 4.3 Safety-Related Warnings and Restrictions:
    - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
    - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
  - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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